MOSFET – Power, Single, P-Channel, μ8FL -30 V, 7.5 mΩ

Features

- Ultra Low R_{DS(on)} to Improve System Efficiency
- Advanced Package Technology in 3.3x3.3mm for Space Saving and Excellent Thermal Conduction
- These Devices are Pb–Free, Halogen Free/BFR Free and are RoHS Compliant

Typical Applications

- Power Load Switch
- Protection: Reverse Current, Over Voltage, and Reverse Negative Voltage
- Battery Management

MAXIMUM RATINGS (T_J = 25° C unless otherwise noted)

Parameter			Symbol	Value	Unit	
Drain-to-Source Voltage			V _{DSS}	-30	V	
Gate-to-Source Voltage			V _{GS}	±25	V	
Continuous Drain Cur-		$T_{C} = 25^{\circ}C$	Ι _D	-47.6	А	
rent $R_{\theta JC}$ (Notes 1, 2)	Steady	$T_C = 85^{\circ}C$		-34.4		
Power Dissipation $R_{\theta JC}$ (Notes 1, 2)	State	$T_C = 25^{\circ}C$	PD	33.8	W	
Continuous Drain Cur-		$T_A = 25^{\circ}C$	I _D	-13.4	А	
rent $R_{\theta JA}$ (Notes 1, 2)	Steady	$T_A = 85^{\circ}C$		-9.6		
Power Dissipation $R_{\theta JA}$ (Notes 1, 2)	State $T_A = 25^{\circ}C$ P		P _D	2.66	W	
Pulsed Drain Current	$T_A = 25^{\circ}C, t_p = 10 \ \mu s$		I _{DM}	-195	А	
Operating Junction and Storage Temperature			T _J , T _{stg}	–55 to 150	°C	
Lead Temperature for Soldering Purposes (1/8" from case for 10 s)			ΤL	260	°C	

Stresses exceeding those listed in the Maximum Ratings table may damage the device. If any of these limits are exceeded, device functionality should not be assumed, damage may occur and reliability may be affected.

THERMAL RESISTANCE MAXIMUM RATINGS

Parameter	Symbol	Value	Unit
Junction-to-Case - Steady State (Drain) (Note 2)	$R_{\theta JC}$	3.7	°C/W
Junction-to-Ambient - Steady State (Note 2)	$R_{\theta JA}$	47	°C/W

1. The entire application environment impacts the thermal resistance values shown, they are not constants and are only valid for the particular conditions noted.

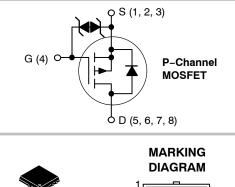
2. Surface-mounted on FR4 board using a 1 in², 2 oz. Cu pad. Assuming a 76mm x 76mm x 1.6mm board.

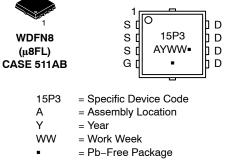


ON Semiconductor®

www.onsemi.com

V _{(BR)DSS}	R _{DS(on)}	ID
-30 V	7.5 m Ω @ –10 V	-47.6 A
-30 V	12 mΩ @ –4.5 V	-47.0 A





(Note: Microdot may be in either location)

ORDERING INFORMATION

Device	Package	Shipping [†]
NTTFS015P03P8ZTAG	WDFN8 (Pb-Free)	1500 / Tape & Reel
NTTFS015P03P8ZTWG	WDFN8 (Pb-Free)	3000 / Tape & Reel

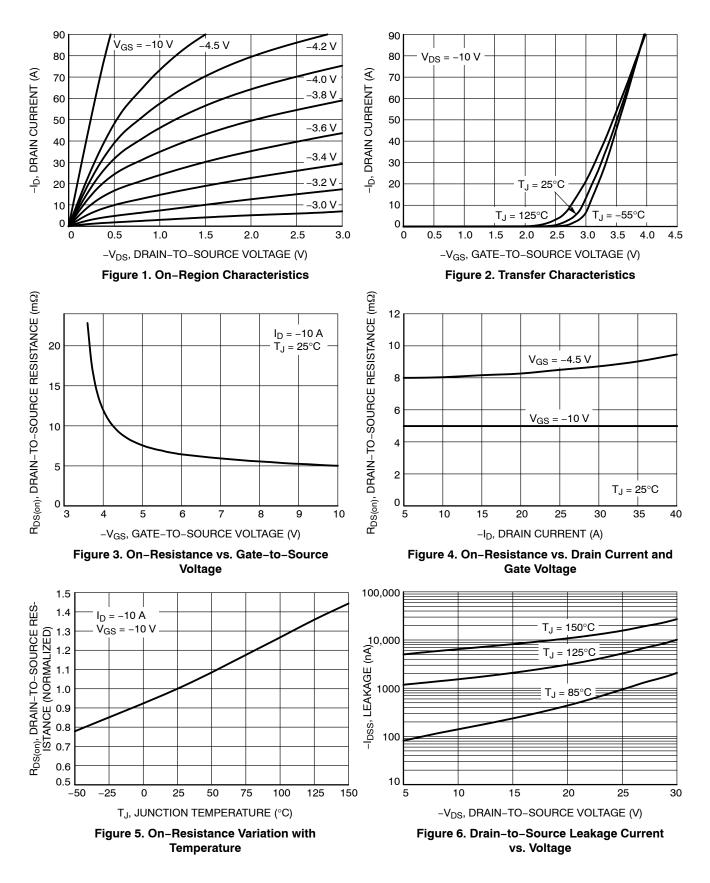
+For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specification Brochure, BRD8011/D.

ELECTRICAL CHARACTERISTICS (T_J = 25°C unless otherwise noted)

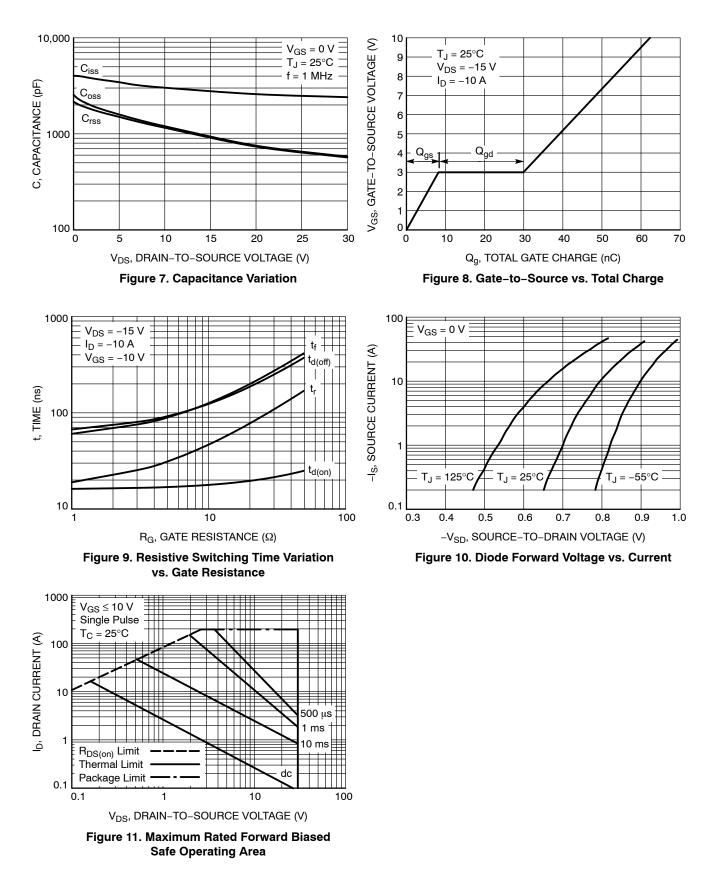
Parameter	Symbol	Test Condition		Min	Тур	Max	Unit
OFF CHARACTERISTICS							
Drain-to-Source Breakdown Voltage	V _{(BR)DSS}	V_{GS} = 0 V, I _D = -250 μ A		-30			V
Drain-to-Source Breakdown Volt- age Temperature Coefficient	V _{(BR)DSS} / T _J	I _D = -250 μA,	ref to 25°C		-4.4		mV/° C
Zero Gate Voltage Drain Current	I _{DSS}	V _{GS} = 0 V, V _{DS} = -24 V	T _J = 25°C			-1.0	μΑ
Gate-to-Source Leakage Current	I _{GSS}	$V_{DS} = 0 V, V_{Gi}$	_S = ±25 V			±10	μΑ
ON CHARACTERISTICS (Note 3)							
Gate Threshold Voltage	V _{GS(TH)}	$V_{GS} = V_{DS}, I_D$	= –250 μA	-1.0		-3.0	V
Threshold Temperature Coefficient	V _{GS(TH)} /T _J	I _D = -250 μA,	ref to 25°C		5.6		mV/°C
Drain-to-Source On Resistance	R _{DS(on)}	$V_{GS} = -10 V,$	l _D = –12 A		5.0	7.5	mΩ
		$V_{GS} = -4.5 V,$	I _D = -10 A		8.0	12	
Froward Transconductance	9 _{FS}	V _{DS} = -5 V, I	_D = -10 A		77		S
CHARGES AND CAPACITANCES	-			-	-	-	-
Input Capacitance	C _{iss}	V_{GS} = 0 V, f = 1.0 MHz, V_{DS} = –15 V			2706		pF
Output Capacitance	C _{oss}				907		
Reverse Transfer Capacitance	C _{rss}				875		
Total Gate Charge	Q _{G(TOT)}	$V_{GS} = -4.5 \text{ V}, V_{DS} = -15 \text{ V},$ $I_D = -10 \text{ A}$ $V_{GS} = -10 \text{ V}, V_{DS} = -15 \text{ V},$ $I_D = -10 \text{ A}$			37		nC
Threshold Gate Charge	Q _{G(TH)}				5.1		-
Gate-to-Source Charge	Q _{GS}				8.2		
Gate-to-Drain Charge	Q _{GD}				21.7		
Total Gate Charge	Q _{G(TOT)}				62.3	105	
SWITCHING CHARACTERISTICS, V	GS = 4.5 V (Note :	3)					
Turn-On Delay Time	t _{d(on)}				25		ns
Rise Time	t _r	V _{GS} = -4.5 V. V	ns = -15 V.		138		-
Turn-Off Delay Time	t _{d(off)}	V _{GS} = -4.5 V, V I _D = -10 A, F	$R_{\rm G} = 6 \Omega$		55		
Fall Time	t _f				98		
SWITCHING CHARACTERISTICS, V	GS = 10 V (Note 3	3)					
Turn-On Delay Time	t _{d(on)}				17		ns
Rise Time	t _r	VGS = -10 V. V	ns = -15 V.		34		1
Turn-Off Delay Time	t _{d(off)}	V_{GS} = -10 V, V_{DS} = -15 V, I_D = -10 A, R_G = 6 Ω			99		-
Fall Time	t _f				97		
DRAIN-SOURCE DIODE CHARACT	ERISTICS					-	
Forward Diode Voltage	V _{SD}	$V_{GS} = 0 V,$ $I_{S} = -10 A$	$T_J = 25^{\circ}C$		-0.8	-1.3	V
			T _J = 125°C		-0.65		1
Reverse Recovery Time	t _{RR}	V_{GS} = 0 V, dI _s /dt = 100 A/µs, I _s = -10 A			40.7		ns
Charge Time	ta				18.4		1
Discharge Time	t _b				22.3		1
Reverse Recovery Charge	Q _{RR}				29		nC

Product parametric performance is indicated in the Electrical Characteristics for the listed test conditions, unless otherwise noted. Product performance may not be indicated by the Electrical Characteristics if operated under different conditions. 3. Pulse Test: Pulse Width \leq 300 µs, Duty Cycle \leq 2%.

TYPICAL CHARACTERISTICS



TYPICAL CHARACTERISTICS



TYPICAL CHARACTERISTICS

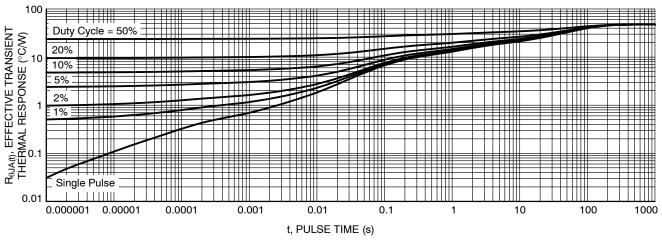


Figure 12. Thermal Response





 DOCUMENT NUMBER:
 98AON30561E
 Electronic versions are uncontrolled except when accessed directly from the Document Repository. Printed versions are uncontrolled except when stamped "CONTROLLED COPY" in red.

 DESCRIPTION:
 WDFN8 3.3X3.3, 0.65P
 PAGE 1 OF 1

 onsemi and ONSEMi are trademarks of Semiconductor Components Industries, LLC dba onsemi or its subsidiaries in the United States and/or other countries. onsemi reserves the right to make changes without further notice to any products herein. onsemi makes no warranty, representation or guarantee regarding the suitability of its products for any particular purpose, nor does onsemi assume any liability arising out of the application or use of any product or circuit, and specifically disclaims any and all liability, including without limitation

special, consequential or incidental damages. onsemi does not convey any license under its patent rights nor the rights of others.

© Semiconductor Components Industries, LLC, 2019

onsemi, ONSEMI, and other names, marks, and brands are registered and/or common law trademarks of Semiconductor Components Industries, LLC dba "onsemi" or its affiliates and/or subsidiaries in the United States and/or other countries. onsemi owns the rights to a number of patents, trademarks, copyrights, trade secrets, and other intellectual property. A listing of onsemi's product/patent coverage may be accessed at <u>www.onsemi.com/site/pdf/Patent_Marking.pdf</u>. onsemi reserves the right to make changes at any time to any products or information herein, without notice. The information herein is provided "as-is" and onsemi makes no warranty, representation or guarantee regarding the accuracy of the information, product features, availability, functionality, or suitability of its products for any particular purpose, nor does onsemi assume any liability arising out of the application or use of any product or circuit, and specifically disclaims any and all liability, including without limitation special, consequential or indental damages. Buyer is responsible for its products and applications using onsemi products, including compliance with all laws, regulations and safety requirements or standards, regardless of any support or applications information provided by onsemi. "Typical" parameters which may be provided in onsemi data sheets and/or specifications can and do vary in different applications and actual performance may vary over time. All operating parameters, including "Typicals" must be validated for each customer application by customer's technical experts. onsemi does not convey any license under any of its intellectual property rights nor the rights of others. onsemi products are not designed, intended, or authorized for use as a critical component in life support systems or any FDA Class 3 medical devices or medical devices with a same or similar classification. Buyer shall indemnify and hold onsemi and its officers, employees, subsidiaries, affiliates, and distributors harmless against all claims, costs,

ADDITIONAL INFORMATION

TECHNICAL PUBLICATIONS:

Technical Library: www.onsemi.com/design/resources/technical-documentation onsemi Website: www.onsemi.com

ONLINE SUPPORT: <u>www.onsemi.com/support</u> For additional information, please contact your local Sales Representative at <u>www.onsemi.com/support/sales</u>